Kinetic Simulations of Diffusion-Controlled Phase Transformations in Cu-Based Alloys

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Abstract. In this chapter, we present kinetic simulations of diffusion-controlled phase transformations in Cu-based alloys by using our most recently developed atomic mobility database (MOBCU) for copper alloys. This database consists of 29 elements including most common ones for industrial copper alloys. It contains descriptions for both the liquid and Fcc_A1 phases. The database was developed through a hybrid CALPHAD approach based on experiments, first-principles calculations, and empirical rules. We demonstrate that by coupling the created mobility database with the existing compatible thermodynamic database (TCCU), all kinds of diffusivities in both solid solution and liquid phases in Cu-based alloys can be readily calculated. Furthermore, we have applied the combination of MOBCU and TCCU to simulate diffusion-controlled phenomena, such as solidification, nucleation, growth, and coarsening of precipitates by using the kinetic modules (DICTRA and TC-PRISMA) in the Thermo-Calc software package. Many examples of simulations for different alloys are shown and compared with experimental observations. The remarkable agreements between calculation and experimental results suggest that the atomic mobilities for Cu-based alloys have been satisfactorily described. This newly developed mobility database is expected to be continuously improved and extended in future and will provide fundamental kinetic data for computer-aided design of copper base alloys.

Introduction

Copper and copper alloys have excellent electrical and thermal conductivities, exhibit good strength and formability [1-3], and are widely used in a variety of products that enable and enhance our everyday lives. In recent years, the research and development of copper alloys for practical industrial applications have increased rapidly. In order to understand and model the behavior of existing alloys during materials processing, and accelerate the development of novel copper alloys, a more efficient and systematic approach is needed. To meet this challenge, computational methods and techniques are indispensable. Among various computational approaches, the CALPHAD (CALculation of PHase Diagram) method [4, 5], which has been recognized as one of the most powerful tools to significantly reduce time and cost during the development of new materials, can effectively provide fundamental thermodynamic and kinetic data that are essential for materials design.

The CALPHAD approach uses a phenomenological methodology by computer coupling phase diagrams and thermochemistry to obtain a self-consistent set of parameters for describing the Gibbs energy of each phase in a multicomponent system from the descriptions of its constituent unary, binary, and ternary systems. Such approach is widely used to develop thermodynamic databases, which collects such a set of parameters in a systematic way. In the past decades, various reliable thermodynamic databases [6-9] have been established based on the CALPHAD approach. The CALPHAD-type thermodynamic databases can be used to calculate both stable or metastable phase equilibria and thermodynamic properties for multicomponent alloys, and thus provide fundamental information to materials design and development. It is known that most of microstructural changes such as phase transformations, homogenization, solidification, and sintering are also related to the diffusion behavior of the alloys in addition to the thermodynamic effects. Therefore, the diffusion

information of the alloys plays also an important role during the processing of advanced materials. As for diffusivity modeling, establishing the so-called atomic mobility database has proven to be the most effective way.

Similar to the thermodynamic databases, the CALPHAD method can be used equally well to develop atomic mobility databases [10-14]. With an atomic mobility database combined with a compatible thermodynamic database, full matrices of various diffusion coefficients as functions of composition and temperature can be calculated. Besides, the use of coupled thermodynamic and atomic mobility databases enables the simulation of many metallurgical processes, ranging from solidification, homogenization, to precipitation hardening. These phase evolution behavior predictions then allow microstructure induced effects on alloy performance to be predicted. Such kinds of simulations make it possible to optimize alloy compositions and predict optimal solidification processes and solution heat treatment temperature ranges without performing many time-consuming and costly experiments.

The accuracy of the predictions is highly dependent on the quality of the thermodynamic and atomic mobility databases that are used. Most recently, a reliable thermodynamic database for copper-based alloys (TCCU) has been established [15] by the present authors *via* a hybrid CALPHAD approach that takes into account of various data from experiments, first-principles calculations and empirical estimations. TCCU has been developed in a 29-element framework, and includes 123 assessed binary and 48 ternary systems, most of which are well described to their full ranges of composition and temperature. With this thermodynamics database, various phase diagrams and thermodynamic properties for different copper alloys can be calculated. Moreover, molar volume data is also incorporated in TCCU. As a result, the density, coefficient of thermal expansion, and lattice parameter of copper alloys can also be predicted. Last but not least, the TCCU database allows us to calculate thermodynamic driving forces for phase transformations and thermodynamic factors for diffusivity modeling, which makes computational kinetics possible in multicomponent systems.

In this chapter, we introduce the development of an atomic mobility database, MOBCU, intended for use in combination with TCCU for copper-based alloys. To our knowledge, MOBCU is the first atomic mobility database targeted specifically at copper alloys. We show the verification of this database by calculating various diffusivities in ternary and higher order systems against experimental data. We validate the database by performing diffusion couple simulations and make comparisons to measured composition profiles. The main objective of this chapter is to simulate kinetic reactions during solidification and subsequent heat treatment processes for typical industrial copper alloys with use of the MOBCU and TCCU databases and the Diffusion Module and Precipitation Module [16-19] in the Thermo-Calc software package.

Database Development and Software Introduction

Database Overview. MOBCU is an atomic mobility database for copper-based alloys, which includes the liquid and Fcc_A1 phases and contains 29 elements: Cu, Ag, Al, As, Au, B, Be, Bi, C, Ca, Cd, Co, Cr, Fe, Mg, Mn, Mo, Nb, Ni, O, P, Pb, Pt, Se, Si, Sn, Ti, Zn and Zr. MOBCU contains critically assessed self- and impurity diffusion data for the elements in the liquid and Fcc_A1 phases. Complete and critical assessments for 36 binary, 26 ternary, and 1 quaternary systems have been included for the Fcc_A1 phase. Besides, 12 binary liquid alloy systems have also been assessed. The assessed systems are summarized in Table 1. This database will be further improved when more experimental data become available. It should be noted that apart from the liquid and Fcc_A1 phases, other phases may also be included in a diffusion simulation but can be treated only as no-diffusion ones. This simplification may work out well in many practical situations if the diffusivities in the other phases are relatively small.

Development Strategy. In the first step, the experimental and theoretically predicted self-diffusion, impurity diffusion, interdiffusion and tracer diffusion coefficients of the Fcc_A1 and liquid phases in the literature are critically reviewed and analyzed. Then, the atomic mobility parameters for the liquid and Fcc_A1 phases are assessed by means of the PARROT module inside DICTRA [16, 17] based on

the selected experimental and theoretically predicted diffusion data. During the assessment, the self-diffusion coefficients and impurity diffusion coefficients are evaluated to obtain the mobility end-members; and the intrinsic diffusion coefficients and interdiffusion coefficients are taken into consideration to introduce the interaction parameters in the binary and ternary systems. Finally, the computational simulations of compositional profiles in diffusion couples are conducted to validate the obtained mobility parameters. The critically assessed thermodynamic descriptions [15] provide reliable thermodynamic factors for the present evaluation of atomic mobilities. It should be noted that such strategy is only suitable for those systems with sufficient diffusion data. Figure 1 shows the schematic diagram for the development of MOBCU.

Table 1 List of the assessed systems in MOBCU.

Fcc Al (36 binary, 26 ternary, and 1 quaternary systems)					
Ag-Al	Ag-Au	Ag-Cu	Ag-Sn	Au-Cu	Al-Cr
Al-Cu	Al-Fe	Al-Mg	Al-Mn	Al-Ni	Al-Pt
Al-Si	Al-Ti	Al-Zn	Cr-Fe	Cr-Ni	Co-Cu
Co-Fe	Co-Ni	Co-Pt	Cu-Fe	Cu-Mg	Cu-Mn
Cu-Ni	Cu-Si	Cu-Sn	Cu-Zn	Fe-Mn	Fe-Ni
Mn-Ni	Mn-Zn	Ni-Pt	Ni-Si	Ni-Ti	Ni-Zn
Ag-Al-Cu	Ag-Au-Cu	Al-Cr-Ni	Al-Cu-Fe	Al-Cu-Mg	Al-Cu-Mn
Al-Cu-Ni	Al-Cu-Si	Al-Cu-Zn	Al-Mn-Ni	Al-Ni-Pt	Al-Ni-Ti
C-Cr-Fe	C-Cr-Ni	C-Fe-Ni	Co-Cu-Ni	Cr-Cu-Ni	Cr-Fe-Ni
Co-Fe-Ni	Cu-Fe-Mn	Cu-Fe-Ni	Cu-Mn-Zn	Cu-Mn-Ni	Cu-Ni-Si
Cu-Ni-Zn	Cu-Sn-Zn	Cu-Mn-Ni-Zn			
Liquid (12 binary systems)					
Ag-Cu	Ag-Sn	Al-Cu	Al-Si	Al-Mg	Al-Ni
Al-Zn	Cu-Sn	Fe-Mn	Fe-Si	Ni-Si	Pb-Sn

Figure 1 The schematic diagram for the development of MOBCU.

It is known that the reported diffusion data for the liquid phase is very limited due to the difficulties of the experiments. In general, an assumption that the liquid diffusion coefficient is $1 \times 10^{-9} \text{ m}^2 \text{ s}^{-1}$ is made when the experimental data is not available. In this case, the calculated diffusivity in the liquid state is independent of temperature and concentration. However, the recent research work [20-26] has demonstrated that accurate liquid diffusivity data is the prerequisite for a quantitative simulation of microstructural evolution during solidification. Therefore, it is of great urgency to establish accurate atomic mobility databases for the liquid phase. Recently, Chen et al. [21] proposed a modified

Sutherland equation to establish the correlation between diffusivity and viscosity. Such an equation allows the prediction of different diffusivities in target alloys and development of atomic mobility databases for melts. The reliability of predicting self- and impurity diffusivities in liquid metals by using this method has been verified by several groups [22, 23, 27-29]. In the present work, for those liquid systems where the experimental data is not available, the modified Sutherland equation proposed by Chen et al. [21] is used for estimation.

Introduction to Diffusion Module and Precipitation Module. The Diffusion Module, known as DICTRA [16, 17] previously, is now an add-on module to Thermo-Calc. It is used to simulate the diffusion controlled transformations in multicomponent systems. During a DICTRA simulation, the multicomponent diffusion equations in various regions of a material are solved under the assumption that thermodynamic equilibrium holds locally at all phase interfaces. The simulations are one-dimensional with three simple geometries: planar, cylindrical and spherical.

The Precipitation Module, formerly referred to as TC-PRISMA [18, 19], is also an add-on module to the Thermo-Calc software package. This module deals with a specific and very important phase transformation process, i.e. precipitation of a large number of small and dispersed particles from a matrix phase in multicomponent systems. It is based on the Langer-Schwartz theory [30] and adopts the Kampmann Wagner numerical approach [31] to solve the governing equation for the evolution of particle size distribution function. With the Precipitation Module, the nucleation, growth, and coarsening of precipitate phases can be simulated simultaneously by tracking the evolution of the probability distribution of the particle number densities, and the results can be obtained about the mean radius, number density, and volume fraction as well as particle size distribution of a precipitate.

In order to perform a simulation in the Diffusion Module and Precipitation Module, both a thermodynamic database and an atomic mobility database are needed. In addition to bulk thermodynamic and kinetic data, a few other physical properties, such as interfacial energy and volume, are needed in precipitation models. These additional physical parameters can be obtained by experiments or other estimation models or first principles calculations.

Model Description

Diffusion Modeling. Let us start this section from the diffusion flux in one dimension (z -direction). The diffusion flux of element i in an n -component substitutional phase within the lattice-fixed frame is expressed as [32]

$$J_i^L = -c_i M_i \nabla \mu_i, \quad (1)$$

where c_i is the molar concentration of element i , and $c_i = x_i/V_m$. x_i and V_m are the molar fraction and molar volume, respectively. M_i is the atomic mobility of element i , and μ_i is the chemical potential. L stands for the lattice-fixed frame. Converting the chemical potential gradient to the concentration gradient in Eq. (1), we have

$$J_i^L = -c_i M_i \sum_{j=1}^{n-1} \left(\frac{\partial \mu_i}{\partial x_j} - \frac{\partial \mu_i}{\partial x_n} \right) \frac{\partial x_j}{\partial z}. \quad (2)$$

Meanwhile, based on Fick's first law, the diffusion flux related to the diffusivity in the lattice fixed frame of reference is given by

$$J_i^L = - \sum_j^{n-1} {}^I D_{ij} \nabla c_j, \quad (3)$$

in which, ${}^I D_{ij}$ is the intrinsic diffusivity with n being the dependent element. Equating Eq. (2) and Eq. (3), the expression for intrinsic diffusivity of i can then be obtained as follows:

$${}^I D_{ij}^n = x_i M_i \left(\frac{\partial \mu_i}{\partial x_j} - \frac{\partial \mu_i}{\partial x_n} \right) = F_{ij}^n RT M_i, \quad (4)$$

with $F_{ij}^n = \frac{1}{RT} x_i \left(\frac{\partial \mu_i}{\partial x_j} - \frac{\partial \mu_i}{\partial x_n} \right)$, which is called the thermodynamic factor. It should be noted here, F_{ij}^n is only related to the thermodynamic description of the system. In the present work, the thermodynamic factor can be directly calculated with use of the thermodynamic database (TCCU) [15]. R is the gas constant ($\text{J mol}^{-1} \text{K}^{-1}$), and T is absolute temperature in K.

Similar to Eq. (3), the diffusion flux of i in the volume-fixed frame is

$$J_i^V = - \sum_j^{n-1} \tilde{D}_{ij}^n \nabla c_j. \quad (5)$$

Here $\tilde{D}_{ij}^n$ is the inter-diffusion coefficient, which means the diffusivity of element i in the gradient of component j with element n as the reference component. V stands for the volume-fixed frame. The diffusion flux in the lattice-fixed frame and volume-fixed frame should satisfy the following relationship [33]

$$J_i^V = J_i^L - x_i \sum_j^n J_j^L. \quad (6)$$

Then, the relationship between inter-diffusivity and intrinsic diffusivity can be evaluated as follows:

$$\tilde{D}_{ij}^n = {}^I D_{ij} - x_i \sum_{k=1}^n {}^I D_{kj}. \quad (7)$$

Combining Eq. (4) and Eq. (7), we have the expression for the inter-diffusivity:

$$\tilde{D}_{ij}^n = \sum_{k=1}^n (\delta_{ki} - x_i) x_k M_k \left(\frac{\partial \mu_k}{\partial x_j} - \frac{\partial \mu_k}{\partial x_n} \right). \quad (8)$$

Besides, based on the Einstein relation [34], the tracer diffusivity (D_i^*) of element i related to the mobility parameter is given as:

$$D_i^* = RT M_i. \quad (9)$$

It is clear from Eq. (9) that the tracer diffusivity is independent of the thermodynamic factor.

The atomic mobility (M_i) can be described from the absolute-reaction theory. According to the suggestion by Andersson and Ågren [35] and Jönsson [36], M_i is expressed as:

$$M_i = \frac{1}{RT} M_0 \exp\left(\frac{-Q_i}{RT}\right)^{mg} \Omega, \quad (10)$$

where M_0 is the frequency factor and Q_i is the activation energy, which are dependent on composition, temperature, and pressure. $^{mg}\Omega$ is the ferromagnetic coefficient. For the liquid and Fcc_A1 copper alloys, the ferromagnetic contribution to the diffusion coefficient is negligible, therefore $^{mg}\Omega$ is unit. Merge the frequency factor and activation energy into one parameter, and let $\Phi_i = -Q_i + RT \ln M_0$, Eq. (10) can be rewritten as:

$$M_i = \exp\left(\frac{-\Phi_i}{RT}\right) \frac{1}{RT}. \quad (11)$$

Again following the suggestion of Andersson and Ågren [35], Φ_i can be represented by using the Redlich-Kister polynomial [37] in the spirit of the CALPHAD method:

$$\Phi_i = \sum_j x_j \Phi_i^j + \sum_p \sum_{j>p} x_j x_p \left[\sum_{k=0}^p \Phi_i^{p,j} (x_p - x_j)^k \right] + \sum_p \sum_{j>p} \sum_{q>p} x_j x_p x_q \left[\sum_s v_{pq}^s \Phi_i^{p,j,q} \right] \quad (s = p, j, q), \quad (12)$$

where Φ_i^j is the value of Φ_i for element i in pure j , and $\Phi_i^{p,j}$ and $\Phi_i^{p,j,q}$ are the binary and ternary interaction parameters, respectively. The coefficients Φ_i^j , $\Phi_i^{p,j}$ and $\Phi_i^{p,j,q}$ can be evaluated from the experimental diffusion coefficients, i.e. tracer diffusivity, intrinsic diffusivity and inter-diffusivity. The parameter v_{pq}^s is in the form:

$$v_{pq}^s = x_s + (1 - x_p - x_j - x_q) / 3. \quad (13)$$

The chemical potential μ_i in Eqs. (1), (4) and (8) is given by

$$\mu_i = G_m + \frac{\partial G_m}{\partial x_i} - \sum_{j=1}^n x_j \frac{\partial G_m}{\partial x_j}, \quad (14)$$

where G_m is the molar Gibbs energy of the target phase, i.e. the liquid or Fcc_A1 phase in the present work, which is described as:

$$G_m = \sum_{j=1}^n x_j {}^0G_j + RT \sum_{j=1}^n x_j \ln(x_j) + \sum_p \sum_{j>p} x_p x_j \left[\sum_{k=0}^p L_{pj} (x_p - x_j)^k \right] + \sum_p \sum_{j>p} \sum_{q>p} x_p x_j x_q \left[\sum_{s=0}^p v_{pq}^s L_{pq} \right] \quad (15)$$

($s = p, j, q$)

in which, 0G_j is the reference Gibbs energy for each pure element. L_{pj} and L_{pq} are the assessed binary and ternary interaction parameters, respectively. In the present work, the reliable molar Gibbs energy descriptions of the liquid and Fcc_A1 phases can be directly obtained from our recently developed copper-based thermodynamic database (TCCU).

Modified Sutherland Equations. One of the major obstacles to establish the atomic mobility database for liquid multicomponent alloys is the lack of adequate measurements of diffusion coefficients due to experimental difficulties caused by convections in melts. In the present work, MOBCU includes also the atomic mobility data for the liquid phase. As mentioned in *Section Development Strategy*, for those liquid systems without experimental diffusion data, the recently proposed modified Sutherland equation [21] is utilized to estimate the Arrhenius formula for the self-diffusivity and impurity diffusivity in pure metallic melts. The expressions for estimated Arrhenius formula of self- and impurity diffusivities are given below as [21]:

$$D_i^i = {}^0D_i^i \cdot \exp\left(\frac{-Q_i^i}{RT}\right), \quad D_i^j = {}^0D_i^j \cdot \exp\left(\frac{-Q_i^j}{RT}\right), \quad (16)$$

with

$${}^0D_i^i = \frac{3.2178 \times 10^{-16} \cdot e^{\frac{\alpha_i T_i^m}{3}} (V_i^m)^{1/3} \sqrt{T_i^m}}{C_1 W_i^{1/2}}, \quad (17)$$

$$Q_i^i = (C_2 + \frac{1}{2} + \frac{\alpha_i}{3} T_i^m) R T_i^m, \quad (18)$$

$${}^0D_i^j = \frac{2.1452 \times 10^{-16} \cdot e^{(2\alpha_j - \frac{\alpha_i}{1+\alpha_i(T_j^m - T_i^m)})T_j^m/3} (V_j^m)^{2/3} \sqrt{T_j^m}}{C_1 W_j^{1/2} [1 + \alpha_i(T_j^m - T_i^m)]^{1/3}} \cdot \left(\frac{1 + \frac{3\eta_j}{\beta r_j}}{1 + \frac{2\eta_j}{\beta r_j}} \right), \quad (19)$$

$$Q_i^j = (C_2 + \frac{1}{2} + \frac{2\alpha_j}{3} T_j^m - \frac{1}{3} \cdot \frac{\alpha_i T_j^m}{1 + \alpha_i(T_j^m - T_i^m)}) R T_j^m, \quad (20)$$

where η_i , α_i , r_i , W_i , V_i and T_i^m are the dynamic viscosity, the radius of the diffusing unit, the thermal coefficient, the atomic mass, the absolute molar volume and the melting point of the pure element i , respectively. β in Eq. (19) is the coefficient of sliding friction between the diffusing particle and medium. The value of β is determined by the atomic radii and melting temperatures of the solute and solvent elements. When a large solute atom moves among smaller solvent atoms, the coefficient β becomes infinite. In another extreme case where a small solute atom moves among solvent atoms of an equal or larger size, the small solute atoms can travel well enough between the gaps of the larger solvent atoms. In this case, β is equal to 0. Besides, when the melting temperature of solute i (T_i^m) is lower than that of solvent j (T_j^m), the coefficient β can thus also be regarded as equal to 0. C_1 and C_2 are constants, which are suggested to be $(1.80 \pm 0.39) \times 10^{-8} \text{ (JKmol}^{-1/3})^{1/2}$ and (2.34 ± 0.20) by Chen et al. [21], respectively.

Verification and Validation of the Database

In order to verify and validate the present mobility database, the comparison between calculated diffusivities/simulated diffusion behaviors and corresponding experimental data in various copper-based alloys is performed. In the following two sections, some representative results are presented.

Calculation of Diffusivities. All diffusivity data collected for the binary, ternary and quaternary systems given in Table 1 are used to verify the presently developed mobility database. In this section, various calculated diffusivities i.e. self-, tracer and chemical diffusivities in both the liquid and Fcc_A1 phases are compared with the reported experimental data.

Figure 2(a) presents the presently calculated self-diffusivities of Al, Cu, Fe, Mn, and Zn in the liquid state along with the experimental data [38-43] and theoretically predicted data [44-55]. In Fig. 2(b), the calculated tracer diffusivities of Cu (blue lines) in liquid Al-20at.%Cu and Ag-85.4at.%Cu alloys are compared with the reported experimental data [56-58]. Besides, the calculated tracer diffusivities of Ni (red lines) in liquid Al-20at.%Ni and Si-20at.%Ni alloys along with measured data [59, 60] is also presented in Fig. 2(b). As shown in the figures, the calculated liquid diffusivities agree excellently with both measurements and theoretical predications.

Figure 2 (a) Calculated self-diffusivities of Al, Cu, Fe, Mn and Zn in the liquid state compared with experimental data [38-43] and theoretical predicted data [44-55]; (b) calculated tracer diffusivity of Cu in Al-Cu, Ag-Cu melts, and tracer diffusivity of Ni in Al-Ni and Ni-Si melts along with experimental data [56-60]. A constant, M , has been added to separate the data.

Figure 3 (a) Comparison between the calculated interdiffusion coefficients in fcc Cu-Zn alloys from 973 to 1213 K and experimental data [61-65]; (b) calculated tracer diffusivities of Cu and Ni in several fcc Cu-Ni-Zn ternary alloys along with experimental data [66-68]. A constant, M , has been added to separate the data.

Figure 3(a) shows the comparison between the calculated interdiffusion coefficients in fcc Cu-Zn alloys from 973 to 1213 K and the measurements available in the literature [61-65]. A good agreement between the calculations and the experiments is obtained. Figure 3(b) presents the calculated temperature dependence of the tracer diffusivities of Cu (blue lines) and Ni (red lines) in several fcc Cu-Ni-Zn ternary alloys, which can reproduce well the experimental data [66-68]. Moreover, the values of tracer diffusivity of Cu are larger than that of Ni in Cu-Ni-Zn system as can be easily seen in Fig. 3(b). The good agreement between present calculation and experimental diffusivity data for both the liquid and Fcc_A1 phases indicates the reliability of MOBCU.

Figure 4 shows presently predicted contour map of main interdiffusion coefficients ($\tilde{D}_{AlAl}^{Cu}$ and $\tilde{D}_{MnMn}^{Cu}$) in the fcc Cu-Al-Mn system at 800 °C. As presented in Fig. 4, $\tilde{D}_{AlAl}^{Cu}$ and $\tilde{D}_{MnMn}^{Cu}$ show quite

different composition dependent behaviors in the copper corner of the Cu-Al-Mn ternary system. Both $\tilde{D}_{AlAl}^{Cu}$ and $\tilde{D}_{MnMn}^{Cu}$ increase as the increase of the concentration of Al and Mn, but the diffusivity of Al is more sensitive with concentration comparing with that of Mn. Besides, the diffusion of Al shows stronger concentration dependence on the Cu-Al side than the Cu-Mn side, as shown in Fig. 4(a), while the diffusivity of Mn is more sensitive to concentration on the Cu-Mn side. The presently predicted diffusion behaviors in Cu-Al-Mn alloys have been verified by the reported experimental information [69].

Figure 4 The predicted contour map for the main interdiffusion coefficients (a) $\tilde{D}_{AlAl}^{Cu}$, and (b) $\tilde{D}_{MnMn}^{Cu}$ in fcc Cu-Al-Mn alloys at 800 °C.

Simulation of Diffusion Couples. The reliability of present mobility database is then validated by comparing the predicted concentration profiles and diffusion paths in several ternary and quaternary diffusion couples with the reported experimental data. The simulation is performed by using the Diffusion Module together with the mobility database (MOBCU) and thermodynamic database (TCCU).

The Cu-Sn-Zn based alloys are one of the most important commercial copper alloys with high strength and corrosion resistances [70, 71]. To have a better understanding of the Cu-Sn-Zn system, an accurate description of its diffusion behavior is needed. Hereunder we shall show the above verified mobility database is capable to predict the concentration profiles and diffusion paths in Cu-Sn-Zn diffusion couples. Figures 5(a) and 5(b) show the simulated concentration profiles of Cu-4.7 at.%Zn/Cu-6.9at.%Sn and Cu/Cu-2.4at.%Zn-6.2at.%Sn diffusion couples annealed at 800 °C for 78300 s, compared with experimental measurements from Takahashi et al. [72]. The calculated diffusion paths for the corresponding diffusion couples under the same simulated conditions are presented in Fig. 5(c), which coincide extremely well with the corresponding experimental data points [72]. In general, if one draws a straight line that links the terminal compositions of a single-phase ternary diffusion couple, the diffusion path for the diffusion couple should intersect with the straight line at least one time [73]. Due to the different diffusion coefficients and the constraint on the mass balance of the three diffusion species in the diffusion zone, both diffusion paths are S-shaped. The excellent agreements indicate the presently developed mobility database has a reliable diffusion description for the Cu-Sn-Zn ternary system.

Figure 5 Simulated concentration profiles for Cu-Sn-Zn ternary diffusion couples (a) Cu-4.7 at.%Zn/Cu-6.9at.%Sn, (b) Cu/Cu-2.4at.%Zn-6.2at.%Sn, and (c) corresponding diffusion paths along with experimental measurements (symbols) [72]. The diffusion couples annealed at 800 °C for 74830 s.

With the atomic mobility parameters in binary and ternary systems, the diffusion properties in quaternary systems can also be reasonably predicted based on direct extrapolations. Figure 6 presents the concentration profiles and diffusion fluxes of two fcc Cu-Ni-Mn-Zn quaternary diffusion couples, which were annealed at 775 °C for 172800 s. Figs. 6(a) and 6(c) depict the simulated concentration profiles and diffusion fluxes for the Cu-21.3at.%Ni-17.6at.%Zn/Cu-20.3at.%Ni-9.2at.%Mn diffusion couple, respectively. The simulated concentration profiles for Cu, Mn, Ni and Zn lie very close to the experimental data [74]. It can be found in Figs. 6(a) and 6(c) that the slopes of the concentration profiles for the Cu-21.3at.%Ni-17.6at.%Zn/Cu-20.3at.%Ni-9.2at.%Mn diffusion couple have same signs on both right and left sides of the Matano plane, while the slopes of diffusion fluxes are of opposite signs. Such behavior indicates that this diffusion couple has a normal homogenization diffusion process. The concentration profiles and diffusion fluxes for the Cu-18.6at.%Zn-10.4at.%Mn/Cu-21.3at.%Ni-17.6at.%Zn diffusion couple are shown in Figs. 6(b) and 6(d). As shown in Fig. 6(b), there are humps on the concentration profiles of Cu and Mn, which can be explained by the uphill diffusion phenomena. Such phenomena can be further verified by the simulated diffusion fluxes. As shown in Fig. 6(d), the slope of the diffusion flux for Cu changes from negative to positive on both left and right sides of the Matano plane, which indicates that the flow of

the Cu atoms migrates against its concentration gradient. Similar explanations can be made for Mn. The general good agreement between the calculations and measurements demonstrates the predictive power of the CALPHAD method embodied in the present atomic mobility database and suggests a high confidence level in making direct extrapolations into higher-order systems on the basis of the information in binary and ternary systems.

Figure 6 Simulated and measured concentration profiles of Cu, Mn, Ni and Zn for (a) Cu-21.3at.%Ni-17.6at.%Zn/Cu-20.3at.%Ni-9.2at.%Mn and (b) Cu-18.6at.%Zn-10.4at.%Mn/Cu-21.3at.%Ni-17.6at.%Zn diffusion couples annealed at $775\text{ }^{\circ}\text{C}$ for 172800 s. The corresponding diffusion fluxes are shown in (c) and (d) respectively.

Kinetic Simulation of Phase Transformations – Database Applications

Simulation of Solidification Process. Solidification is one of the most critical processes in copper alloys, which will determine the formation of the bulk microstructure and then directly affect the mechanical and chemical properties of the alloys [75]. Therefore, being able to accurately simulate the solidification behavior of a copper alloy is of great importance. Based on the presently obtained atomic mobility database together with the above mentioned thermodynamic database, the solidification process in copper alloys can be modeled by using the Diffusion Module of Thermo-Calc. During the simulation, the diffusion data in both the liquid and solid (Fcc_A1) phases are considered. In this section, the simulations for solidification in Cu-Pb-Sn and Cu-Pb-Sn-Zn alloys are presented.

The solidification behaviors of Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn (nominal composition of Copper alloy C83600) alloys have been measured by Korojy et al. [76]. The solidification processes of these two alloys are simulated to make a comparison with the measurements. For the simulation, the initial liquid composition is assumed to be homogeneous and equal to the nominal alloy composition; the starting temperature for the solidification process is selected to be 20 °C higher than the equilibrium melting temperatures, i.e. 1030 °C for Cu-4.7wt.%Pb-5.2wt.%Sn and 1010 °C for Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn, which have been predicted by thermodynamic equilibrium calculations with use of TCCU; and the ending temperature is from the experimental information [76], i.e. 880 °C for alloy Cu-4.7wt.%Pb-5.2wt.%Sn and 888 °C for Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn, respectively. The simulation times are then calculated by $time = \frac{(T_m + 20) - T_{end}}{v_c}$, where T_m is the melting temperature,

and v_c is the cooling rate. The cooling rate is set to 0.16 °C /s, which was reported by Korojy et al. [76]. The one-dimensional simulated domains are 285 μm and 350 μm for the Cu-5.2wt.%Sn-4.7wt.%Pb and Cu-5.2wt.%Sn-4.5wt.%Zn-4.9wt.%Pb alloys, which are estimated by measuring experimental half-width of the dendrite cross section and volume fraction of primary phase of the investigated alloys.

Figure 7 Simulated fraction of solid phase during the solidification process in Cu-4.7wt.%Pb-5.2wt.%Sn alloy, compared with experimental data [76]. The cooling rate is 0.16 °C/s.

Figure 7 presents the DICTRA simulated increase of solid fraction (solid blue line) upon cooling of the Cu-4.7wt.%Pb-5.2wt.%Sn alloy along with the experimental data [76]. The simulation results show an excellent agreement with the measurements. Besides, the equilibrium solidification results (black dashed line) and Scheil solidification results (dotted line) are also given in Fig. 7. Both of these results only depend on the phase equilibria in the system considered. It is not surprising that the equilibrium solidification results deviate from the experimental data because equilibrium solidification can only be attained with an extremely slow cooling rate. On the other hand, it could be easily seen that the Scheil solidification results are quite close the measurements, and show only slight underestimation. The Scheil solidification model assumes that the local equilibrium exists at the liquid/solid interface and the diffusion is absent in the solid phase but with perfect mixing in the liquid phase. With the cooling rate used in the experiments [76], it seems that the Scheil assumptions are fairly good for the Cu-4.7wt.%Pb-5.2wt.%Sn alloy. It should be noted this does not mean that the Scheil model will always be sufficient for copper alloys. As a matter of fact, the cooling rate is not a

part of the Scheil equation. Therefore, the effect of cooling rate and possible substantial back diffusions of some elements during slow cooling cannot be considered in a simple Scheil calculation. In order to provide an accurate prediction of the solidification behavior, the DICTRA simulation is recommended.

Figure 8 Calculated composition profile through half dendrite cross section in (a) Cu-4.7wt.%Pb-5.2wt.%Sn alloy, and (b) Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn alloy during the solidification process along with experimental data [76]. The cooling rate is 0.16 °C/s.

Figure 8 compares the simulated concentration profiles through half-width of the dendrite cross sections in the Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn alloys with experimental data [76]. As can be seen, the presently simulated concentration profiles for Sn and Cu agree reasonably well with the experimental information except that for Zn. Our simulated concentration of Zn in the solid phase is higher than the experimental one, as shown in Fig. 8(b). It is noticed that the experimental weight fraction of Zn in both liquid (2.30 wt.%) and solid (4.35 wt.%) phases after solidification process are less than the nominal composition (4.5 wt.%), which indicates that the total mass of Zn in the treated alloy is less than that in the nominal alloy. Due to the obvious mass loss of Zn during the experiment, the simulated result for Zn is acceptable. As shown in Figs. 8(a) and (b), the concentration of solute Sn and Zn increases from the central to the edge of the dendrite in both Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn alloys, while that of Cu shows a decrease trend. Moreover, the simulated content of Sn in the liquid phase is larger than that of in the solid phase in both the Cu-Pb-Sn and Cu-Pb-Sn-Zn alloys, while the content of Zn shows an opposite trend. These simulated results have been confirmed by the experiments [76]. Besides, the length of the region on the left side of solid/liquid interface in Fig. 8 can be served as the simulated half-width of the dendrite after the solidification process. It shows that the simulated half-widths of dendrite in Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn are 223 μm and 256 μm respectively, which agree reasonably with the experimental measured ones (225 μm and 268 μm).

Microsegregation occurs from solute partitioning during solidification processes. Such phenomenon will cause the formation of defects during the casting process and also has negative effects on the product quality due to the inhomogeneous microstructure and undesirable primary precipitates. The microsegregation behaviors of Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn during the solidification can be predicted in the same DICTRA solidification simulation. The degree of microsegregation of the solutes can be quantified by the segregation coefficient, which is defined as follows [77, 78]:

$$k_i = \frac{c_i^s}{c_i^l}, \quad (21)$$

where c_i^s and c_i^l are the concentrations of element i in the solid and liquid near the interface, respectively. A value of k_i less than unity indicates that the element i prefers to remain in the liquid, and the concentration of i thus increases in the liquid during solidification, whereas a value greater than unity indicates that the element is partitioning to the dendrite. The segregation coefficient highly depends on the system and solidification conditions, such as the composition and cooling rate. The predicted segregation coefficients for Sn and Zn in the Cu-4.7wt.% Pb-5.2wt.% Sn and Cu-4.9wt.% Pb-5.2wt.% Sn-4.5wt.% Zn alloys during the solidification process are presented in Fig. 9. The segregation coefficient of Sn in both the Cu-Pb-Sn and Cu-Pb-Sn-Zn alloys is less than 1, and the segregation coefficient increases as the increase of solid fraction. While, the segregation coefficient for Zn in Cu-4.9wt.% Pb-5.2wt.% Sn-4.5wt.% Zn alloy increase from 0.94 at the start of solidification to 1.41 at the end of the solidification, as shown in Fig. 9, which indicates that Zn has the inverse segregation during the solidification process. Besides, the segregation coefficient of Sn in Cu-4.7wt.% Pb-5.2wt.% Sn alloy is larger than that in Cu-4.9wt.% Pb-5.2wt.% Sn-4.5wt.% Zn alloy at the same solid fraction. It means that the addition of Zn will increase the partitioning of Sn to the dendrite during the solidification. The predicted microsegregation behaviors in the Cu-Pb-Sn and Cu-Pb-Sn-Zn alloys have been verified by the reported experimental measurements [76].

Figure 9 Predicted segregation coefficients of Sn and Zn in Cu-4.7wt.%Pb-5.2wt.%Sn and Cu-4.9wt.%Pb-5.2wt.%Sn-4.5wt.%Zn alloys with solid fraction during the solidification process. The cooling rate is 0.16 °C /s.

Simulation of Precipitation. Precipitation particle size and its distribution have a decisive influence on the subsequent mechanical properties of high-strength and highly conductive precipitation hardened copper alloys. The shape of precipitate particles, which is determined by the competition between the interfacial energy and elastic strain energy, has long been recognized as one of the potentially important factors in determining the strength of alloys. New settings are available in the Precipitation Module to treat non-spherical morphologies, including cuboid, plate, and needle, in the latest release (Version 2017b) [79]. In this section, the precipitations in several copper alloys with different precipitate morphologies are simulated by using the Precipitation Module (Version 2017b).

In order to use the Precipitation Module, both a thermodynamic and a kinetic database are needed. This is same as to use the Diffusion Module, but not enough. For precipitation simulation, additional physical properties are required as input data, for example, interfacial energy, volume, elastic constants or moduli. It should be noted that the Precipitation Module has an estimation model

available for predicting interfacial energy. In the present simulations, experimental interfacial energy values will be used directly when suitable; otherwise the model estimated one will be accepted. The molar volume data for both the matrix and precipitate are directly calculated from the thermodynamic database (TCCU), which contains the volume parameters for each phase.

The first selected example is the precipitation of fcc Co-Fe in the Cu-0.68 at.%Co-1.52 at.%Fe alloy, which has been experimentally investigated by Watanabe et al. [80]. Their samples were cold-rolled to 3 mm in thickness, solution-treated at 1303 K for 5 h in vacuum to ensure an initial structure of homogeneous single fcc phase before being quenched into cold water, and then annealed at 873, 923, and 973 K in vacuum. To simulate the final isothermal aging process, one needs to start from the nucleation of particles, and this can be readily tackled by using the Precipitation Module. Watanabe et al. [80] found that the shape of the particles could change from sphere to cuboid when the particles became large. However, they reported no data on the cubic factor. Therefore, we have ignored the morphological evolution in this simulation. The treatment of cuboids will be shown later in this section in our last case study, where experimental cubic factor data are available for precipitation hardening in another copper alloy.

Figure 10 Comparison of the simulated (a) mean size and (b) number density of fcc Co-Fe precipitates in Cu-0.68 at.%Co-1.52 at.%Fe alloy annealed at 973, 923, and 873 K with the experimental data [80]. The solid symbols are for spherical particles; and the open symbols are for cuboid particles, with the size of equivalent-volume sphere in (a).

In the present simulation, homogeneous nucleation is assumed on the basis of experimental information. The adopted value for the interfacial energy is 0.22 J/m^2 , same as that reported by Watanabe et al. [80] for 973 K. The simulated results on mean radius and number density are shown in Figure 10 together with the measurements. As can be easily seen, not only spherical but also cubic particles can be accounted for remarkably well. The normalized particle size distributions (PSD) for the 973 K precipitation at 0.5 and 48 h were also reported by Watanabe et al. [80] for this copper alloy. Our predictions are now compared with their measurements in Figure 11. The agreement is excellent considering the large uncertainty usually associated with the PSD experiments.

Figure 11 Comparison of the simulated particle size distribution of fcc Co-Fe precipitates in Cu-0.68 at.%Co-1.52 at.%Fe alloy annealed at 973 K for (a) 0.5 h and (b) 48 h with the experimental data [80].

Figure 12 Simulated average length (red line) and width (black line) of rod-shaped precipitates with aging time for Cu-1.86wt.%Ni-0.45wt.%Si alloy at (a) 923 K, and (b) 948K compared with reported experimental data [82].

The Cu-Ni-Si alloy is a precipitation strengthening-type alloy and receives a lot of attention for its high strength, high electrical conductivity and excellent bending workability [81]. Watanabe and Monzen [82] experimentally determined precipitation behavior of the Cu-1.86 wt.% Ni-0.45 wt.% Si alloy at 923 and 948 K. Their measurements show that the precipitate (Ni_2Si) is a rod-shape one with an aspect ratio of 13. In the present simulation, the needle morphology is selected, and the aspect ratio is directly taken from the experimental measurements [82]. The model estimated interfacial energy (0.22 J/m^2) is used. The type of nucleation sites is set to 'Bulk', conforming to the experimentally observed homogenous nucleation. In Figure 12, a comparison has been made between the simulated mean length (red line) and mean width (black line) of the precipitates and their measured values. As can be seen, the simulation results agree with the measurements extremely well although there is nothing or any parameter that has been fitted. This fact suggests once we can create accurate thermodynamic and kinetic data pieces for the puzzle of phase transformations, they fall into place naturally.

Fujii et al. [83] reported that Co-Cr precipitates in a Cu matrix with shapes between a sphere and a cubic. The shape of cuboid morphology is determined by the competition between interfacial energy and elastic strain energy. The spherical-cuboidal transition during precipitation can be characterized by using a cubic factor (η), which is defined as the ratio of the maximum radius to the minimum radius of the supersphere. In Fig. 13, the simulated cubic factors for the Cu-1.63wt.%Co- 0.41wt.%Cr alloy annealed at 973 K for 48 hours is presented. During the simulation, homogenous nucleation has been assumed. The interfacial energy value (0.38 J/m^2) is taken from the model estimated value, and transformation strain is set to ‘Calculate from molar volume’ to obtain a purely dilatational strain. The default elastic constant values ($C_{11}=168.4 \text{ GPa}$, $C_{12}=121.4 \text{ GPa}$, $C_{44}=75.4 \text{ GPa}$) suggested by the software for copper alloys have been used. It is apparent that the shape of particles changes from sphere to cuboid with increasing size. The simulation results are compared with experimental data collected by Fujii et al. [83]. The prediction curve passes beautifully through the scattered experimental data points.

Figure13 Comparison of the presently simulated cubic factor distribution of precipitate in the Cu-1.63wt.%Co-0.41wt.%Cr alloy with experimental results [83]. The alloy was annealed at 973 K for 48 hours.

Summary

In order to simulate kinetics of diffusion controlled phase transformations in copper-based alloys, we have successfully developed a specific atomic mobility database (MOBCU) for this type of materials. MOBCU contains 29 elements (Cu, Ag, Al, As, Au, B, Be, Bi, C, Ca, Cd, Co, Cr, Fe, Mg, Mn, Mo, Nb, Ni, O, P, Pb, Pt, Se, Si, Sn, Ti, Zn and Zr) and the descriptions for both the liquid phase and the Fcc_A1 phase. The comparison between various calculated and experimental diffusion coefficients shows the high fidelity of this database in reproducing the experimental data for various diffusivities. The good agreement between the model-predicted and the measured concentration profiles for a variety of diffusion couples, especially for the ternary and quaternary diffusion couples, further validates the present atomic mobility database. Moreover, this mobility database has been applied to fulfil our primary goal of the present investigation. We have simulated the solidification and precipitation processes in several representative copper alloys by using the Diffusion Module and Precipitation Module in Thermo-Calc. It has been shown that this newly developed mobility database can be utilized to make rather accurate predictions of phase transformation kinetics. Future improvements and extensions of this atomic mobility database are expected to occur simultaneously with the compatible thermodynamic database.

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